

Surface-mount service distribution board with three-point turn-lock, $\mathbf{W} = 1000$ mm, $\mathbf{H} = 1260$ mm



Part no. BP-0-1000/12 Article no. 100973

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Mounting type		Surface mounted
Material		Sheet steel
Door interlock		Three-point turn-lock
Installation site		Indoor
Degree of Protection		IP30
Surface finish		With powder coating
Width	mm	1000
Depth	mm	262
Height	mm	1260
Colour		light gray (RAL 7035)

Design verification as per IEC/EN 61439

Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees, calculated as per IEC 60890 Individual enclosure for wall mounting Pv C0 144 Middle enclosure for wall mounting Pv C0 141 Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees, calculated as per IEC 60890 Individual enclosure for wall mounting Pv C0 298 Starting enclosure for wall mounting Pv C0 289 Middle enclosure for wall mounting Pv C0 289 Middle enclosure for wall mounting	Design verification as per IEC/EN 61439			
Individual enclosure for wall mounting Py CO 144 Heat dissipation, at an ambient temperature of 35°C, delta 1:33 degrees, celculated as per IEC 60890 Individual enclosure for wall mounting Py CO 288 Individual enclosure for wall mounting Py CO 288 Starting enclosure for wall mounting Py CO 288 Starting enclosure for wall mounting Py CO 288 Individual enclosure for wall mounting Py CO 388 Starting enclosure for wall mounting Py CO 388 Individual enclosure for wall mounting Individual enclosure for wall enclosure for wall enclosure for wall enclosure for wall e	Technical data for design verification			
Starting enclosure for wall mounting Middle enclosure for wall mounting Py C0 141 Heat dissipation, at an ambient temperature of 39°C, delta 1:35 degrees, calculated as per EC 08390 Individual enclosure for wall mounting Py C0 Starting enclosure for wall mounting Meets the product standard's requirements. Meets the product standard's requirements. Meets the product standard's requirements. Not enclosure without lifting aids. Rest the product standard's requirements. Rosposition of resistance of insulating materials to abnormal heat and fire due to internal electric effects Starting enclosure without lifting aids. Rest the product standard's requirements. Rosposition of enclosures without lifting aids. Rest the product standard's requirements. Rosposition of enclosures without lifting aids. Rosposition of enclosures without liftin				
Middle enclosure for wall mounting Heat dissipation, at an ambient temperature of 25°C, delta 1:35 degrees, colloulated as per IC 50080 Individual enclosure for wall mounting Py C0 298 Natring enclosure for wall mounting Niddle enclosure wall mounting Niddle enclosure wall mounting Niddle enclosure wall mounting Niddle enclosure without standard's requirements. Nidests the product standard's requirements. Notes the product standard's requirements. Note relevant to indoor installations. Notes the product standard's requirements. Notes the product stand	Individual enclosure for wall mounting	P_{V}	CO	149
Heat dissipation, at an ambient temperature of 35°C, delta T. 35 degrees, calculated as per IC 60889 Individual enclosure for wall mounting Py CO 288 CEN 61439 design verification 10.2 Strength of materials and parts 10.2 Strength of materials and parts 10.2.2 Corrosion resistance 10.2.3 I Verification of thermal stability of enclosures 10.2.3 I Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects 10.2.3 I Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.5 Insulation against electric shock 10.3.0 Degree of protection of ASSEMBLIES 10.3.1 Degree of protection of ASSEMBLIES 10.3.1 Degree of protection of switching devices and components 10.3 Insulation properties 10.4 Insulation properties 10.5 Insulat	Starting enclosure for wall mounting	P_V	CO	144
Individual enclosure for wall mounting Py CO 298 Starting enclosure for wall mounting Py CO 298 Middle enclosure for wall mounting Py CO 298 CEN 61499 design verification ID 2 Strength of materials and parts ID 2 Strength of materials and parts ID 2 Strength of materials and parts ID 2.2 Corrosion resistance ID 2.3.1 Verification of thermal stability of enclosures ID 2.3.2 Verification of resistance of insulating materials to normal heat and fire due to internal electric effects ID 2.4.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects ID 2.4.1 Verification of Poststance of insulating materials to abnormal heat and fire due to internal electric effects ID 2.4.1 Verification of Poststance of insulating materials to abnormal heat and fire due to internal electric effects ID 2.5.1 Inscriptions ID 2.6.1 Mechanical impact ID 2.7 Inscriptions ID 3.0 Agree of protection of ASSEMBLIES ID 3.0 Insurance and creepage distances ID 4.1 Clearances and creepage distances ID 4.2 Insurances and creepage distances ID 5.4 Total on against electric strength ID 8.5 Incorporation of switching devices and components ID 9.1 Insulation properties ID 9.2 Power-frequency electric strength ID 9.3 Insulation properties ID 9.4 Tevers for external conductors ID 9.4 Tevers for external conductors ID 9.5 Insulation properties ID 9.6 Tevers frequency electric strength ID 9.6 Tevers frequency electric stre	Middle enclosure for wall mounting	P_V	CO	141
Starting enclosure for wall mounting Py C0 283 CEN 61439 design verification 10.2 Strength of materials and parts 10.2 Strength of materials and parts 10.2.3 I Verification of thermal stability of enclosures 10.2.3 I Verification of thermal stability of enclosures 10.2.3 Verification of tensistance of insulating materials to abnormal heat and fire due to internal electric effects 10.2.3 Extrength of materials and parts 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.5 Litting 10.2.5 Litting 10.2.5 Extrength of Protection of ASSEMBLIES 10.2.7 Inscriptions 10.2.7 Inscriptions 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.6 Incorporation of switching devices and components 10.8 Connections for external conductors 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.3 Impulse withstand voltage 10.9.3 Impulse withstand voltage 10.9.4 Festing of enclosures made of insulating materials 10.1 Temperature rise 10.1 Temperature rise 10.1 Temperature rise 10.1 Short-circuit rating 10.2 Electromagnetic compatibility. 10.3 In panel builder's responsibility. 10.4 In panel builder's responsibility. 10.5 In panel builder's responsibility. 10.6 Incorporation of switching devices and components 10.9 Power-frequency electric strength 10.9 In panel builder's responsibility.				
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CFEN 61439 design verification 10.22 Strength of materials and parts 10.2.2 Corrosion resistance 10.2.3.1 Verification of thermal stability of enclosures 10.2.3.2 Verification of resistance of insulating materials to normal heat 10.2.3.3 Verification of resistance of insulating materials to normal heat 10.2.3.3 Verification of resistance of insulating materials to abnormal heat 10.2.3.3 Verification of resistance of insulating materials to abnormal heat 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.5 Lifting 10.2.6 Mechanical impact 10.2.7 Inscriptions 10.3 Degree of protection of ASSEMBLIES 10.3 Degree of protection of ASSEMBLIES 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.6 Incorporation of switching devices and components 10.8 Connections for external conductors 10.9 Power-frequency electric strength 10.9.4 Testing of enclosures made of insulating material 10.9.5 There is a substance of insulating material 10.10 Temperature rise 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.13 Electromagnetic compatibility 10.15 Electromagnetic compatibility 10.15 Electromagnetic compatibility 10.15 Electromagnetic compatibility 10.15 Electromagnetic compatibility 10.16 Electromagnetic compatibility 10.16 Electromagnetic compatibility 10.17 Electromagnetic compatibility 10.18 Electromagnetic compatibility 10.18 Electromagnetic compatibility 10.18 Electromagnetic compatibility 10.19 Electromagnetic compatibility 10.19 Electromagnetic compatibility 10.10 Electromagnetic compatibility	Starting enclosure for wall mounting	P_V	CO	289
10.2.2 Strength of materials and parts 10.2.2 Corrosion resistance 10.2.3.1 Verification of thermal stability of enclosures 10.2.3.2 Verification of resistance of insulating materials to normal heat 10.2.3.3 Verification of resistance of insulating materials to normal heat and fire due to internal electric effects 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.5 Lifting 10.2.6 Mechanical impact 10.2.7 Inscriptions 10.2.6 Mechanical impact 10.3.0 Begree of protection of ASSEMBLIES 10.3.0 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.6 Incorporation of switching devices and components 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.1 Thermal electrical circuits and connections 10.1 Thermal electric strength 10.2 Insulation properties 10.1 Thermal electric strength 10.3 Impulse withstand voltage 10.4 Testing of enclosures made of insulating material 10.1 Thermal electric strength 10.2 Thermal electric strength 10.3 Impulse withstand voltage 10.4 Testing of enclosures made of insulating material 10.1 Thermal electric strength 10.2 The panel builder's responsibility. 10.3 Impulse withstand voltage 10.4 The panel builder's responsibility. 10.5 The panel builder's responsibility.	Middle enclosure for wall mounting	P_V	CO	283
Meets the product standard's requirements.	IEC/EN 61439 design verification			
10.2.3.1 Verification of thermal stability of enclosures Meets the product standard's requirements. 10.2.3.2 Verification of resistance of insulating materials to normal heat and fire due to internal electric effects Meets the product standard's requirements. 10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects Most relevant to indoor installations. 10.2.4 Resistance to ultra-violet (UV) radiation Not relevant to indoor installations. 10.2.5 Mechanical impact IKO7 INCOME. INCOME. INCOME. INCOME. 10.2.7 Inscriptions Meets the product standard's requirements. 10.3. Degree of protection of ASSEMBLIES IP30 Is the panel builder's responsibility. 10.4. Clearances and creepage distances Is the panel builder's responsibility. 10.5 Protection against electric shock Co.1.0; meets the product standard's requirements. 10.8 Incorporation of switching devices and components Is the panel builder's responsibility. 10.9 Insulation properties Is the panel builder's responsibility. 10.9 Insulation properties U; = 440 V AC 10.9.3 Impulse withstand voltage 4kV 10.9.4 Testing of enclosures made of insulating material Does not apply to metal enclosures. 10.10 Temperature rise The panel builder's responsibility. 10.11 Short-circuit rating Is the panel builder's responsibility. 10.12 Electromagnetic compatibility Is the panel builder's responsibility. 10.14 Electromagnetic compatibility Is the panel builder's responsibility. 10.15 Lectromagnetic compatibility	10.2 Strength of materials and parts			
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10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects 10.2.4 Resistance to ultra-violet (UV) radiation 10.2.5 Lifting 10.2.6 Mechanical impact 10.3.1 Meets the product standard's requirements. 10.3.1 Meets the product standard's requirements. 10.3.1 Meets the product standard's requirements. 10.3.2 Meets the product standard's requirements. 10.3.2 Meets the product standard's requirements. 10.3.3 Meets the product standard's requirements. 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.15 Lietromagnetic compatibility 10.15 Lietromagnetic compatibility 10.16 Lietromagnetic compatibility 10.17 Lietromagnetic compatibility 10.18 Lietromagnetic compatibility 10.19 Lietromagnetic compatibility 10.10 Lietromagnetic compatibility	10.2.3.1 Verification of thermal stability of enclosures			Meets the product standard's requirements.
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10.2.5 Lifting 10.2.6 Mechanical impact 10.2.7 Inscriptions Meets the product standard's requirements. 10.3 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.12 Electromagnetic compatibility 10.12 Electromagnetic compatibility 10.10 Insulation properties 10.10 Temperature rise 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.12 Electromagnetic compatibility 10.12 Electromagnetic compatibility 10.13 Insulation properties 10.10 Temperature rise 10.10 Temperature rise 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.12 Electromagnetic compatibility 10.13 Insulation properties 10.14 Short-circuit rating 10.15 Short-circuit rating 10.16 Temperature rise 10.17 Short-circuit rating 10.18 Short-circuit rating 10.19 Short-circuit rating 10.10 Temperature rise 10.10 Tempera				Meets the product standard's requirements.
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10.2.7 Inscriptions 10.3 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.11 Electromagnetic compatibility 10.12 Electromagnetic compatibility Meets the product standard's requirements. Is the panel builder's responsibility. Is the panel builder's responsibility. Is the panel builder's responsibility. U _i = 440 V AC 4 kV Does not apply to metal enclosures. The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. Is the panel builder's responsibility. Is the panel builder's responsibility.	10.2.5 Lifting			Does not apply to enclosures without lifting aids.
10.3 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 11.15 Lettromagnetic compatibility 12.16 Lettromagnetic compatibility 13.17 Lettromagnetic compatibility 14.18 Lettromagnetic compatibility 15.19 Lettromagnetic compatibility 16.10 Temperature rise 17.10 Temperature rise 18.10 Lettromagnetic compatibility 18.10 Lettromagnetic compatibility 19.10 Lettrom	10.2.6 Mechanical impact			IK07
10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility Is the panel builder's responsibility. Is the panel builder is responsibility. Is the panel builder is responsibility. Is the panel builder is responsibility. Is the panel builder's responsibility.	10.2.7 Inscriptions			Meets the product standard's requirements.
10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.5 Is the panel builder's responsibility. 10.6 Incorporation of switching devices and components 10.8 the panel builder's responsibility. 10.9 Is the panel builder's responsibility. 10.9.1 The panel builder is responsibility. 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility. 10.14 Short-circuit strength 10.15 Short-circuit rating 10.16 Short-circuit rating 10.17 Short-circuit rating 10.18 Short-circuit rating 10.19 Short-circuit rating 10.10 Short-circuit rating 10.10 Short-circuit rating 10.10 Short-circuit rating 10.11 Short-circuit rating 10.11 Short-circuit rating 10.12 Short-circuit rating 10.13 Short-circuit rating 10.14 Short-circuit rating 10.15 Short-circuit rating 10.16 Short-circuit rating 10.17 Short-circuit rating 10.18 Connections is the panel builder's responsibility. 10.19 Short-circuit rating 10.10 Short-circuit rating 10.10 Short-circuit rating 10.10 Short-circuit rating 10.11 Short-circuit rating 10.12 Short-circuit rating	10.3 Degree of protection of ASSEMBLIES			IP30
10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility Is the panel builder's responsibility. Is the panel builder's responsibility. Is the panel builder's responsibility. Is the panel builder is responsibility. Is the panel builder's responsibility.	10.4 Clearances and creepage distances			Is the panel builder's responsibility.
10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility Is the panel builder's responsibility. Is the panel builder's responsibility. Is the panel builder is responsibility. Is the panel builder is responsibility. Is the panel builder's responsibility.	10.5 Protection against electric shock			$<$ 0.1 $\Omega;$ meets the product standard's requirements.
Is the panel builder's responsibility. 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 4 kV 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility Is the panel builder's responsibility. Is the panel builder's responsibility.	10.6 Incorporation of switching devices and components			Is the panel builder's responsibility.
10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 4 kV 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. 10.11 Short-circuit rating 10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.7 Internal electrical circuits and connections			Is the panel builder's responsibility.
10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 4 kV 10.9.4 Testing of enclosures made of insulating material Does not apply to metal enclosures. The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. 10.11 Short-circuit rating Is the panel builder's responsibility. 10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.8 Connections for external conductors			Is the panel builder's responsibility.
10.9.3 Impulse withstand voltage 4 kV 10.9.4 Testing of enclosures made of insulating material Does not apply to metal enclosures. The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. 10.11 Short-circuit rating Is the panel builder's responsibility. 10.12 Electromagnetic compatibility Is the panel builder's responsibility.				
10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility Does not apply to metal enclosures. The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. Is the panel builder's responsibility. Is the panel builder's responsibility.	10.9.2 Power-frequency electric strength			$U_i = 440 \text{ V AC}$
10.10 Temperature rise The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. 10.11 Short-circuit rating Is the panel builder's responsibility. 10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.9.3 Impulse withstand voltage			4 kV
provide heat dissipation data for the devices. 10.11 Short-circuit rating Is the panel builder's responsibility. 10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.9.4 Testing of enclosures made of insulating material			Does not apply to metal enclosures.
10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.10 Temperature rise			
	10.11 Short-circuit rating			Is the panel builder's responsibility.
10.13 Mechanical function Meets the product standard's requirements.	10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
	10.13 Mechanical function			Meets the product standard's requirements.

Technical data ETIM 6.0

Distribution boards (EG000023) / Small distribution board (EC000214)

Electric engineering, automation, process control engineering / Electrical installation, device / Electrical distribution system (incl. small distribution board) / Small distribution board (ecl@ss8.1-27-14-24-09 [ACN387008])

Number of rowsModerationModerationModerationType of coverJoorJoorCover modelJoorNoTransparent cover/doorModerationSteelMaterial housingJoorSteelHeightJoorModerationWidthJooModerationDepthJoorModerationBuilt-in depthJoorModerationInternal depthJoorModerationDIN-railModerationModerationWith mounting plateJoorNoExtension possibleJoorNoEMC-versionJoorNoColourModerationNoColourModerationNoBAL-numberJoorNoJoorNoJoorNoColourNoNoSee of protection (IP)NoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoorNoNoJoor <th>(eci@ss8.1-2/-14-24-09 [ACN38/008])</th> <th></th> <th></th>	(eci@ss8.1-2/-14-24-09 [ACN38/008])		
Width in number of modular spacings 6 46 Type of cover Door Closed Cover model No No Transparent cover/door Steel No Material housing 100 Steel Height m 100 Width p 100 Depth m 26.5 Built-in depth m 57.5 Internal depth p 75.5 With mounting plate No No Extension possible No No EMC-version P Yes Colour P No RAL-number P 7035 Degee of protection (IP) P 1930	Mounting method		Surface mounting
Type of cover Door Cover model Closed Transparent cover/door No Material housing Steel Height Builder Width mm 1280 Builder mm 262.5 Builder mm 275.5 Internal depth mm 275.5 Vidth mounting plate No Yes Extension possible Yes No EMC-version FMC-version No Colour Grey FWC RAL-number TOS TOSS Degree of protection (IP) FMC-version TOSS	Number of rows		9
Cover model Keel Transparent cover/door Steel Material housing mm 1260 Width mm 1000 Width mm 262.5 Built-in depth mm 0 Internal depth mm 257.5 DIN-rail Yes With mounting plate No No Extension possible Yes No EMC-version No Fee Colour No Fee RAL-number 7035 Fee Degree of protection (IP) 1930 1930	Width in number of modular spacings		46
Transparent cover/door No Material housing Steel Height mm 1260 Width mm 000 Depth mm 262.5 Built-in depth mm 27.5 Internal depth mm 27.5 With mounting plate No Ves Extension possible Yes Ves EMC-version No No Colour Grey Grey RAL-number 7035 Tested Degree of protection (IP) 1930 1930	Type of cover		Door
Material housing Stel Height 1260 Width 1000 Depth mm 62.5 Built-in depth mm 57.5 Internal depth mm 57.5 With mounting plate No No Extension possible yes Yes EMC-version No Yes Colour No Forey RAL-number 7035 7035 Degree of protection (IP) 1930 1930	Cover model		Closed
Height mm 1260 Width mm 1000 Depth mm 62.5 Built-in depth mm 9 Internal depth mm 57.5 DIN-rail Yes With mounting plate No Extension possible Yes EMC-version No Colour Rol RAL-number 7035 Degree of protection (IP) Po	Transparent cover/door		No
Widthmm1000Depthmm262.5Built-in depthmm0Internal depthmm257.5DIN-railyesWith mounting plateNoNoExtension possibleYesEMC-versionNoNoColourGreyRAL-numberGreyDegree of protection (IP)1930	Material housing		Steel
Depthmm262.5Built-in depthmm0Internal depthmm257.5DIN-railYesWith mounting plateNoNoExtension possibleYesEMC-versionNoNoColourNoNoRAL-numberGreyDegree of protection (IP)1930	Height	mm	1260
Built-in depth Internal depth DIN-rail With mounting plate EMC-version Colour RAL-number Built-in depth Internal depth Interna	Width	mm	1000
Internal depth DIN-rail With mounting plate Extension possible EMC-version Colour RAL-number RDL-number Degree of protection (IP) DESTABLE TO STATE	Depth	mm	262.5
DIN-rail DIN-rail With mounting plate Extension possible EMC-version Colour RAL-number Degree of protection (IP) Yes Yes No Grey Grey 1035 P306 P406 P507 P508 P608 P608	Built-in depth	mm	0
With mounting plateNoExtension possibleYesEMC-versionNoColourGreyRAL-number7035Degree of protection (IP)IP30	Internal depth	mm	257.5
Extension possibleYesEMC-versionNoColourGreyRAL-number7035Degree of protection (IP)IP30	DIN-rail		Yes
EMC-versionNoColourGreyRAL-number7035Degree of protection (IP)IP30	With mounting plate		No
ColourGreyRAL-number7035Degree of protection (IP)IP30	Extension possible		Yes
RAL-number 7035 Degree of protection (IP) IP30	EMC-version		No
Degree of protection (IP) IP30	Colour		Grey
	RAL-number		7035
With lock No	Degree of protection (IP)		IP30
	With lock		No